SD001BP50B SD001BP50B-R

SILICON BYPASS DIODE

PRELIMINARY TECHNICAL DATA DATASHEET 5566, PRELIMINARY.1

SILICON BYPASS DIODE

APPLICATIONS:

This series of diodes are intended to be used as solar cell bypass diodes to provide protection for the string in the event of a failure of one of the cells in the string. The triangular shape and weld able surfaces allow for easy integration with the solar cells with rugged attachment. The devices are intended for use in terrestrial solar arrays as well as in space based solar arrays for telecommunications, scientific or defense satellites, space stations and scientific exploration missions.

FEATURES / BENEFITS:

- ✓ Triangular shape for integration with chamfered corners of solar cells
- ✓ Low forward voltage drop
- √ Low reverse leakage
- ✓ Silicon Die fabricated on a MIL-PRF-19500 JANS qualified manufacturing line
- ✓ Available with Class H or Class K element evaluation IAW MIL-PRF-19500

ELECTRICAL CHARACTERISTICS:

Maximum Ratings:

All ratings are @ T_A = 25 °C unless otherwise specified

| Characteristics | Symbol | Condition | Min. | Max. | Units |
|--|--------------------|--------------------------|------|------|-------|
| Peak Inverse Voltage | V_{RWM} | - | | 50 | V |
| Breakdown Voltage | V _{BR1} | @ I _{BR} =100uA | 60 | | V |
| Max. Average Forward Current | I _{F(AV)} | @ 55°C ⁽¹⁾ | | 3.0 | Α |
| Max. Peak One Cycle Non- Repetitive Surge Current | I _{FSM} | 8.3 ms, sine pulse (1) | | 50 | А |
| Max. Storage and Junction Temperature | TJ | - | -55 | +175 | °C |
| Maximum Weight | | - | | 0.03 | grams |

⁽¹⁾ When mounted on suitable PCB

Electrical Characteristics:

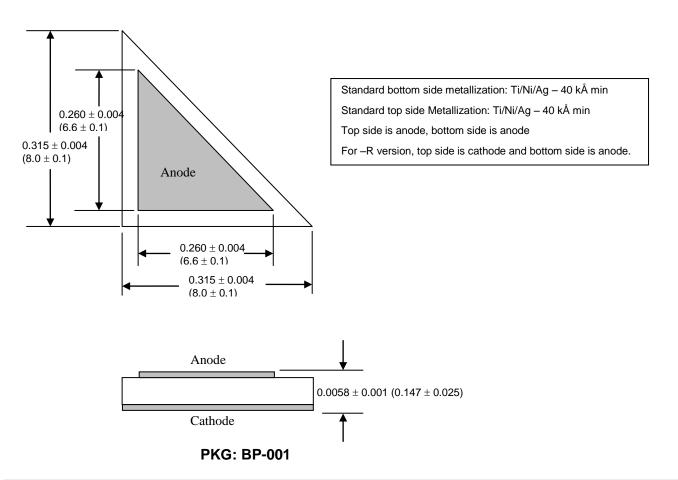
| Characteristics | Symbol | Condition | Max. | Units |
|--|-----------------|--|------|-------------|
| Max. Forward Voltage Drop | V_{F1} | 1.0A, pulse, T _J = 25 °C | 0.80 | V |
| | V_{F2} | 2.0A, pulse, T _J = 25 °C | 0.82 | V |
| | V_{F3} | 1A, pulse, T _J = 125 °C | 0.76 | > |
| | V_{F4} | 1A, pulse, T _J = -55 °C | 1.0 | V |
| Max. Reverse Current | I _{R1} | $V_R = V_{RWM}$, pulse, $T_J = 25 ^{\circ}C$ | 1.0 | μΑ |
| | I _{R2} | $V_R = V_{RWM}$, pulse, $T_J = 125$ °C | 10 | μΑ |
| Max. Junction Capacitance C _T | | $V_R = 5V$, $T_C = 25$ °C | 250 | pF |
| | | $f_{SIG} = 1MHz,$ | | |
| | | $V_{SIG} = 50 \text{mV (p-p)}$ | | |

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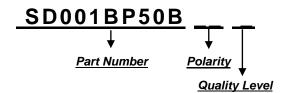
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PACKAGE DIMENSIONS (inches/mm):



PART ORDERING INFORMATION:



| Suffix | Part Number | Description |
|--------|--------------|----------------------------------|
| Blank | SD001BP50B | Cathode Bottom |
| -R | SD001BP50B-R | Anode Bottom |
| Blank | SD001BP50B | Commercial |
| Н | SD001BP50BH | Class H Level Element Evaluation |
| K | SD001BP50BK | Class K Level Element Evaluation |



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